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RESPONSE UNDER 37 CFR 1.116  
EXPEDITED PROCEDURE  
EXAMINING GROUP 2818

PATENT APPLICATION  
Docket No.: 8750-045  
Client Ref. No.: SPX200306-0020US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: In-Ku KANG

Serial No.: 10/632,700 Examiner: Tran, Mai Huong C.  
Filed: July 31, 2003 Group Art Unit: 2818  
Confirmation No.: 3617  
For: MULTI-CHIP MODULE HAVING BONDING WIRES AND  
METHOD OF FABRICATING THE SAME

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT AFTER FINAL REJECTION UNDER 37 CFR 1.116**

Responsive to the Final Office Action, Paper No. 102005, dated March 22, 2005,  
please amend the application as follows.

Amendments to the Claims are reflected in the listing of claims which begins on  
page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.